APPLICA	BLE STAN	DARD									
	Operating temperature range  Voltage  Current		30 V AC / DC range humi				_	-10 °C to 50 °C (packed condition)			
RATING					humid	erating or storage midity range		Re	Relative humidity 90%MAX(no		
			0.20 A Appl			cable c	able		t=0.12±0.02mm, gold	platin	g
			SPEC	CIFICA	10ITA	NS					
IT	EM		TEST METHOD				RE	QU	IREMENTS	QT	АТ
CONSTR	UCTION										
General examination		Visually a	Visually and by measuring instrument.			According to drawing.				×	×
Marking		Confirmed visually.				(note 1,2)				×	×
ELECTRI	ICAL CHA	RACTE	RISTICS								
Voltage proof		90 V AC 1	for 1 min.			No flashover or breakdown.				×	×
Insulation resistance		100 V DC.			50 MΩ MIN.				×	×	
Contact resistance		AC 20 mV MAX (1KHz), 1 mA.				200 ms	Ω ΜΑΧ.			×	×
		= (13.12), 1 1111.				Including FPC bulk resistance (L=8mm)					
MECHAN	IICAL CHA	ARACTE	RISTICS			meradi	ilg i i O bo	anc ic	Jointaine (L-onnin)		
Vibration	1107 (2 01 17	_	y 10 to 55 Hz, half amplitud	de 0.75 mr	n,	① No	electrical of	disco	ontinuity of 1 us.	×	Τ_
		for 10 cycles in 3 axial directions.			-	<ol> <li>No electrical discontinuity of 1 μs.</li> <li>Contact resistance: 200 mΩ MAX.</li> </ol>				Ĺ	
Shock		981 m/s <sup>2</sup> , duration of pulse 6 ms at 3 times in 3 both axial directions.				③ No damage, crack and looseness of parts.			×	_	
Mechanical operation		10 times	insertions and extractions.			① Contact resistance: 200 mΩ MAX.			×	-	
FPC retention force		Measured by applicable FPC. (thickness of FPC shall be t=0.12mm				② No damage, crack and looseness of parts.  Direction of insertion: 2.95 N MIN (note 3)			×	-	
		`	condition)								
ENVIRO	MENTAL	CHARA	ACTERISTICS			•				•	
Corrosion sa	It mist	Exposed	at 35±2°C, 5% salt water	spray for 9	96 h.	Contac	t resistanc	ce: 2	00 mΩ MAX.	×	_
Rapid change of temperature		Temperature -55 $\rightarrow$ +15 to +35 $\rightarrow$ +85 $\rightarrow$ +15 to +35 $^{\circ}$ C Time 30 $\rightarrow$ 2 to 3 $\rightarrow$ 30 $\rightarrow$ 2 to 3 min Under 5 cycles.			<ol> <li>Contact resistance: 200 mΩ MAX.</li> <li>Insulation resistance: 50 MΩ MIN.</li> <li>No damage, crack and looseness of parts.</li> </ol>				×	_	
Damp heat (steady state)		Exposed at 40±2°C, Relative humidity 90 to 95 %, 96 h.				<b>©</b> 140	damago, c	Jiaoi	varia recognices of parts.	×	-
Damp heat,cyclic		Exposed at -10 to +65°C, Relative humidity 90 to 96 %, 10 cycles, total 240 h.				<ol> <li>Contact resistance: 200 mΩ MAX.</li> <li>Insulation resistance: 1 MΩ MIN.</li> </ol>			×	_	
					(at high humidity)  ③ Insulation resistance: 50 MΩ MIN. (at dry)						
						4 No damage, crack and looseness of parts.					
Dry heat			posed at 85±2°C, 96 h.			① Contact resistance: 200 mΩ MAX.				×	_
Cold		'	osed at -55±3°C, 96 h.			② No damage, crack and looseness of parts.				×	-
Sulphur dioxide [JIS C 60068-2-42]		Relative I	elative humidity 80±5%			Contact resistance: 200 mΩ MAX.				×	-
Hydrogen sulphide E		Exposed	±5 ppm for 96 h. bosed at 40±2°C, ative humidity 80±5% ,							×	<del> </del>
0.0			ppm for 96 h.								
COUN	T DE	-	ON OF REVISIONS		DESIG	NED			CHECKED	DATE	
REMARK							ABBBOY	(ED	NIC MIVAZAUI	10	11 11
\∟IVIAI\\\							APPROV CHECKE	-	NF. MIYAZAKI		11. 14
							DESIGN	_	YH. MICHIDA	1	11. 11
I Inless otherwise specified			ed, refer to IEC 60512			DRAWN		HY. YAMAZAKI			
Unless otherwise specified, refer to IEC 60512.							l				
RS SPECIFICATION SHEET PART				ELC-371819-0				)			
			PART		01.1		64MA-15S-0. 25SH	_	4 10		
ODM HDOO11-		OSE EL	ECTRIC CO., LTD.		CODE	NO.	CL!	ეგი	-4608-0-00	◬	1/2

SPECIFICATIONS							
ITEM	TEST METHOD	REQUIREMENTS	QT	AT			
Solderability	Soldered at solder temperature, 245±3°C for immersion duration, 3±0.3 sec.	A new uniform coating of solder shall cover a minimum of 95% of the surface being immersed.	×	_			
Resistance to soldering heat	1) Reflow soldering: Peak TMP. 250°C MAX. Reflow TMP. over 230°C within 60 sec. Number of allowed reflow cycles 2 times. 2) Soldering irons: TMP. 350±10°C for 5±1 sec.	No deformation of case of excessive looseness of the terminals. ( <i>note 4</i> )	×	_			

## (note1)

This is a top contact point connector with back flip lock system.

## (note2)

Do not close the actuator before inserting FPC even after the connector is mounted onto a PCB.

Closing the actuator without FPC could make the contact gap smaller, which increases the FPC insertion force.

## (note3)

Stabilize the FPC to PCB or something fixed, if pull-up or pull-down force is exepected to be applied to the FPC.

There is a case which the FPC retention force doesn't fullfill the specification depending on the FPC specification.

## (note4)

Blisters which may be generated on the housing do not affect product performance.

Note Q1	Qualification Test AT:Assurance Test X:Applicable Test	DRAWIN	NG NO.	ELC-371819-00-00		
R	RC SPECIFICATION SHEET		PART NO. FH64MA-15S-0. 25Sh			
11.0	HIROSE ELECTRIC CO., LTD.	CODE NO	CL580	-4608-0-00	Δ	2/2